

TAIWAN SEMICONDUCTOR MANUFACTURING CO LTD

Form 6-K

November 14, 2017

**1934 Act Registration No. 1-14700**

**SECURITIES AND EXCHANGE COMMISSION**

**Washington, DC 20549**

**FORM 6-K**

**REPORT OF FOREIGN PRIVATE ISSUER**

**PURSUANT TO RULE 13a-16 OR 15d-16**

**OF THE SECURITIES EXCHANGE ACT OF 1934**

**For the month of November 2017**

**Taiwan Semiconductor Manufacturing Company Ltd.**

**(Translation of Registrant's Name Into English)**

**No. 8, Li-Hsin Rd. 6,**

**Hsinchu Science Park,**

**Taiwan**

**(Address of Principal Executive Offices)**

(Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F.)

Form 20-F

Form 40-F

(Indicate by check mark whether the registrant by furnishing the information contained in this form is also thereby furnishing the information to the Commission pursuant to Rule 12g3-2(b) under the Securities Exchange Act of 1934.)

Yes

No

(If  Yes is marked, indicated below the file number assigned to the registrant in connection with Rule 12g3-2(b): 82: \_\_\_\_\_.)

**SIGNATURES**

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned, thereunto duly authorized.

Taiwan Semiconductor Manufacturing Company Ltd.

Date: November 14, 2017

By /s/ Lora Ho  
Lora Ho  
Senior Vice President & Chief Financial Officer

### **TSMC Board of Directors Meeting Resolutions**

**Hsinchu, Taiwan, R.O.C., November 14, 2017** TSMC (NYSE: TSM) today held a meeting of the Board of Directors, which passed the following resolutions:

1. Approved capital appropriations of approximately US\$4,284.5 million for purposes including:  
1) US\$1,667.5 million for construction of fab facilities; 2) US\$2,617 million for other purposes including:  
Expanding and upgrading advanced technology capacity; Expanding advanced packaging technology capacity;  
Expanding specialty technology capacity; Conversion of logic capacity to specialty technology; First quarter  
2018 R&D capital investments and sustaining capital expenditures.
2. Approved the capital injection of not more than US\$2 billion to TSMC Global Ltd., a wholly-owned BVI subsidiary, for the purpose of reducing foreign exchange hedging costs.

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